Jose Omar Betancourt

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EDUCATION

Ph.D. in Mechanical Engineering

University of California, Berkeley

Designated Emphasis in Computation & Data Science & Engineering

Master of Science in Mechanical Engineering

University of California, Berkeley

Bachelor of Science in Mechanical Engineering

Minor: Applied Mathematics Boise State University, Boise, ID

Bilingual in Spanish and English

TECHNICAL SKILLS

- C++, MATLAB, Numerical Methods, Physics Modeling
- Data Visualization & Analysis, LaTeX, Genomic Optimization

RELEVANT EXPERIENCE

PhD Student, Multiphysics Simulation & Optimization Lab

University of California, Berkeley, Department of Mechanical Engineering

Fall 2020 - Present

Expected: December 2025

Graduated: December 2022

Graduated: May 2020

- Developed voxel-based methods to simulate thermochemical and mechanical processes in woven composite materials during hypersonic re-entry, identifying failure mechanisms and improving material performance in aerospace applications.
- Designed agent-based models using C++, MATLAB, and Python for drone mapping and aerial drop simulations, optimizing flight paths, payload distribution, and autonomous navigation.
- Optimized reduced-order multiphysics models with genetic algorithms, improving model efficiency and for coupled thermomechanical and fluid dynamics processes.
- Head Graduate Student Instructor for *Intro to Finite Element Methods* and *Modeling & Simulation of Advanced Manufacturing Processes* graduate courses.

Research Technician, Microwave Vacuum Electron Devices Lab

Fall 2018 – Spring 2020

Boise State University, College of Engineering, Department of Electrical & Computer Engineering

- Project: Development of Phase-Controlled Magnetron
- Fabricated fixtures using turning lathes and CNC machines to streamline the wafer dye testing process.
- **Designed components** made from Low Temperature Co-Fired Ceramic (LTCC) using **SolidWorks**, ensuring precision in product development.
- Drafted and updated **reports and procedures** for assembly and fabrication processes, maintaining clear documentation for manufacturing.

Mechanical Engineering Intern, L3 Technologies - Electron Devices

Summer 2017 & 2018

- Investigated alternative thermal interface materials to improve heat dissipation in microwave power modules, leading to a 15% temperature decrease and proposing design changes.
- Conducted experiments evaluating performance, cost, and ease of application/removal of materials, providing data-driven recommendations.
- Utilized geometric dimensioning and tolerancing (GD&T) to create 3D solid models and 2D engineering drawings for precise manufacturing specifications.
- Used SolidWorks to perform finite element analysis (FEA), validating experimental results through simulation.
- Coordinated with vendors to compare material costs and performance, informing the selection process for optimal solutions.

Relevant Graduate Coursework

Machine Learning Tools for Energy Transport · Finite Element Methods · Modeling & Simulation of Advanced Manufacturing Processes · Applications of Parallel Computers · Continuum Mechanics · Numerical Solutions to ODEs/PDEs · Model Predictive Control · Failure Analysis of Structural Materials